

GN05009N

GaAs IC

Transmitting amplifier for PHS base station

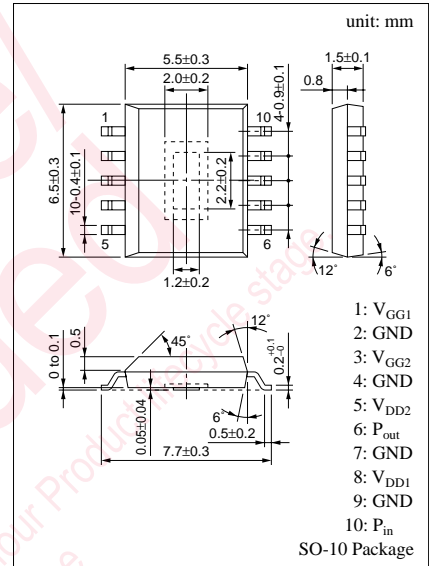
Other communication equipment

■ Features

- High output power amplifier ($P_{out} = 25.5\text{dBm}$)
- Low consumption current (I_{DD} max. 420mA)
- Small surface mount package

■ Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Ratings	Unit
Power supply voltage	V_{DD1}	6	V
	V_{DD2}	6	V
Gate voltage	V_{GG1}	-5	V
	V_{GG2}	-5	V
Circuit current	I_{DD1}	0.12	A
	I_{DD2}	0.36	A
Input power	P_{in}	7	dBm
Operating temperature	T_{opr}	-20 to +90	$^\circ\text{C}$
Storage temperature	T_{stg}	-30 to +120	$^\circ\text{C}$

■ Electrical Characteristics ($T_a = 25 \pm 3^\circ\text{C}$) *1

Parameter	Symbol	Conditions	min	typ	max	Unit
Circuit current*2, 5	I_{DD}	$V_{DD1} = V_{DD2} = 4.8\text{V}$, $P_{out} = 25.5\text{dBm}$			420	mA
Gate current*3, 5	I_{GG}	$V_{DD1} = V_{DD2} = 4.8\text{V}$, $P_{out} = 25.5\text{dBm}$			3	mA
Power gain*5, 6	PG	$V_{DD1} = V_{DD2} = 4.8\text{V}$, $P_{out} = 25.5\text{dBm}$	22		30	dB
Modulation distortion*5, 6	DM_1	$V_{DD1} = V_{DD2} = 4.8\text{V}$, $P_{out} = 25.5\text{dBm}$ $\pm 600\text{kHz}$ Detuning, 192kHz Bandwidth			-56	dBc
Modulation distortion*5, 7	DM_2	$V_{DD1} = V_{DD2} = 4.8\text{V}$, $P_{out} = 25.5\text{dBm}$ $\pm 900\text{kHz}$ Detuning, 192kHz Bandwidth			-60	dBc
Voltage standing wave ratio*5, 7	VSWRin	$V_{DD1} = V_{DD2} = 4.8\text{V}$, $P_{out} = 25.5\text{dBm}$			3	
Harmonics output ratio*4, 5, 7		$V_{DD1} = V_{DD2} = 4.8\text{V}$, $P_{out} = 25.5\text{dBm}$			-35	dBc

*1 Common conditions: $f = 1895.15$ to 1917.95MHz , Duty = 1/2 ($t = 5\text{ms}$), $T_a = 25^\circ\text{C}$ *2 $I_{DD} = I_{DD1} + I_{DD2}$

*3 Current flowing through the gate pin in the measurement circuit diagram.

*4 2nd (2fo), 3rd (3fo), and 4th (4fo) harmonics

*5 V_{GG} is the voltage which adjusts I_{DD} to 0.15A when P_{in} is OFF. P_{out} is the average output power of $\pi/4$ shifted QPSK wave.*6 Sampling inspection items ($n = 10/\text{wafer}$) ($c = 0$)

*7 Design-guaranteed items.

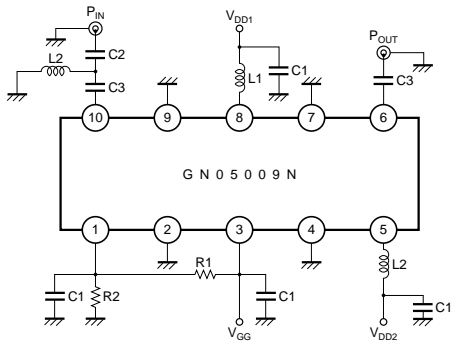
1) About the stability of the load regulation, no abnormal oscillation and no noise increase are caused under following conditions:

Condition: $V_{DD1} = V_{DD2} = 3.5$ to 5V , $V_{GG} = (*1)$, $P_{in} = -25$ to $+7\text{dBm}$, load VSWR ≤ 3 , full phase

2) About the damage capacity, no damage would be caused under following conditions:

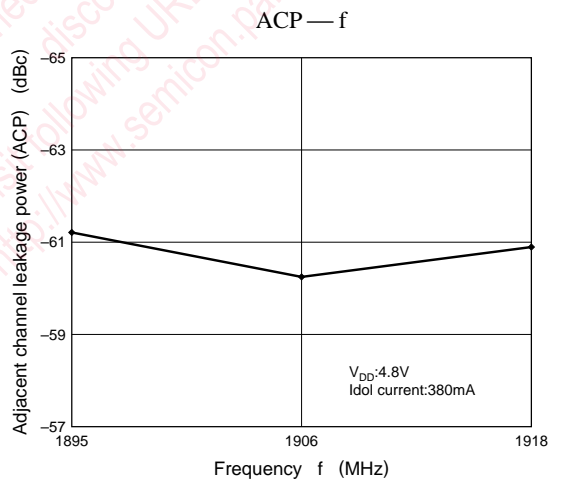
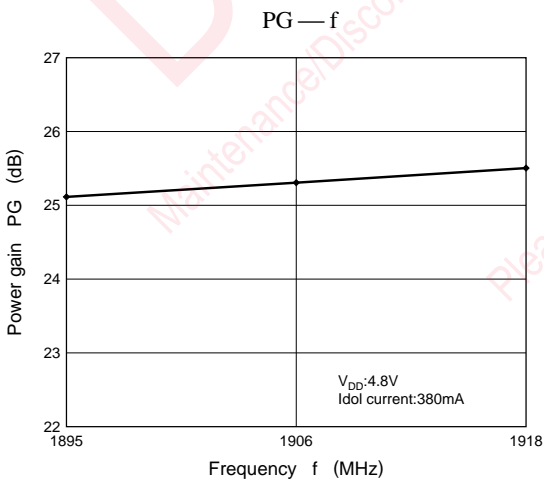
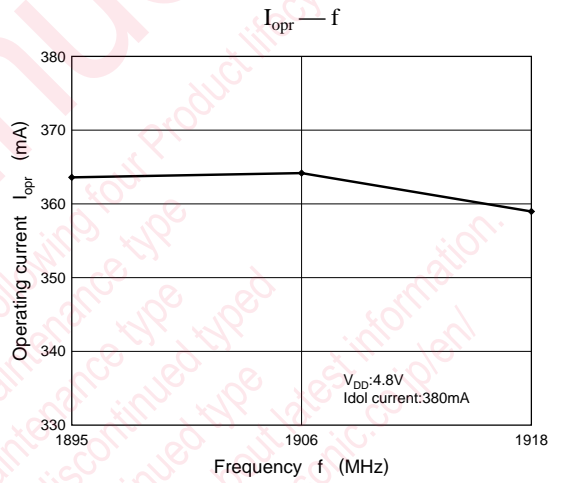
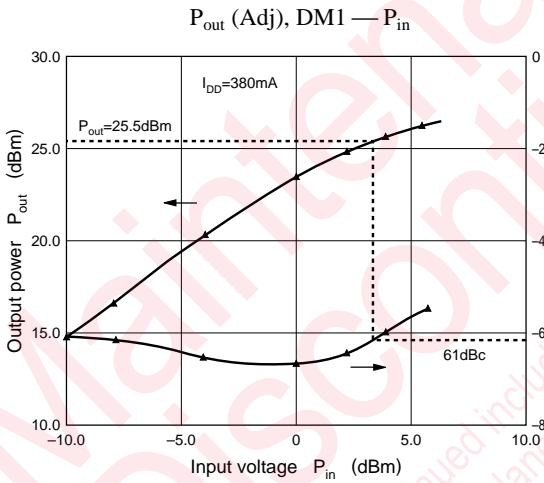
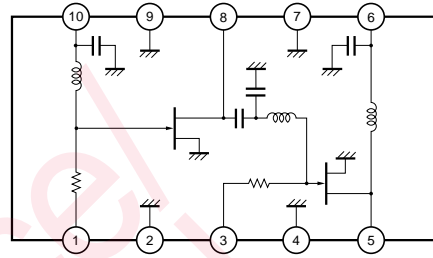
Condition: $V_{DD1} = V_{DD2} = 0$ to 5.2V , $V_{GG} = (*1)$, $P_{in} = -25$ to $+7\text{dBm}$, load VSWR ≤ 3 , full phase, $t < 10\text{s}$

Measurement Circuit



(Component values)
 R1 = 560Ω L1 = 8.2nH C1 = 100pF, 10μF
 R2 = 1.8kΩ L2 = 5.6nH C2 = 1pF
 C3 = 100pF

Circuit-Function Block Diagram



Caution for Safety

 **DANGER**

■ This product contains Gallium Arsenide (GaAs).

GaAs powder and vapor are hazardous to human health if inhaled or ingested. Do not burn, destroy, cut, cleave off, or chemically dissolve the product. Follow related laws and ordinances for disposal. The product should be excluded from general industrial waste or household garbage.

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